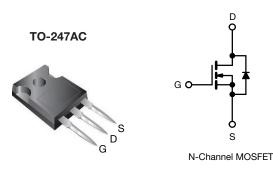
**Vishay Siliconix** 



# **E Series Power MOSFET**

PRODUCT SUMMA	RY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650		
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.156	
Q <sub>g</sub> max. (nC)	96		
Q <sub>gs</sub> (nC)	12		
Q <sub>gd</sub> (nC)	25		
Configuration	Sing	le	



### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-Free and Halogen-Free	SiHG22N60AE-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	600	v	
Gate-Source Voltage		V <sub>GS</sub>	± 30	v	
Continuous Drain Current (T 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1	20	
Continuous Drain Current ( $T_J = 150 \ ^\circ$ C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	12	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	49	
Linear Derating Factor				1.4	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	204	mJ
Maximum Power Dissipation			P <sub>D</sub>	179	W
Operating Junction and Storage Temperature Range	е		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope T <sub>J</sub> = 125 °C		125 °C	d\//dt	70	1//20
Reverse Diode dV/dt <sup>d</sup>			dV/dt	31	V/ns
Soldering Recommendations (Peak temperature) <sup>c</sup>	For	10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 3.8 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62			00.00	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 0.7			°C/W			
	1							
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	unless otherw	ise noted)						
PARAMETER	SYMBOL	-		ONS	MIN.	TYP.	MAX.	UNI
Static		-			I		I	-
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 25	50 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$		to 25 °C, I <sub>C</sub>		-	0.72	-	V/°(
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> = 2		2	-	4	V
	do(iii)	-	$V_{GS} = \pm 20^{\circ}$		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$		-	-	± 1	μA
			= 600 V, V <sub>GS</sub>		-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-		, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		= 11 A	-	0.156	0.180	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	11 A	-	4.8	-	S
Dynamic	•	•				•		
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	1451	-	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$		-	73	-	1	
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz		-	5	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>		(1- 400.)(.)		-	50	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{\rm DS} = 0.0$	/ to 480 V, \	$V_{\rm GS} = 0$ V	-	258	-	
Total Gate Charge	Qg				-	48	96	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 11 A	A, V <sub>DS</sub> = 480 V	-	12	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	25	-	
Turn-On Delay Time	t <sub>d(on)</sub>		•		-	19	38	
Rise Time	t <sub>r</sub>	V <sub>PP</sub> -	= 480 V, I <sub>D</sub> =	11 Δ	-	33	66	
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub> =		-	45	90	ns
Fall Time	t <sub>f</sub>		-		-	21	42	
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, open	drain	0.3	0.6	1.2	Ω
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	bol		-	-	20	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers p - n junction			-	-	49	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>.1</sub> = 25 °C	C, I <sub>S</sub> = 11 A,	$V_{GS} = 0 V$	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	319	638	ns
Reverse Recovery Charge	Q <sub>rr</sub>		$5^{\circ}$ C, $I_{F} = I_{S}$		-	4.9	9.8	μ
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 1	100 A/µs, V <sub>F</sub>	<sub>R</sub> = 25 V	_	28	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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**Vishay Siliconix** 

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

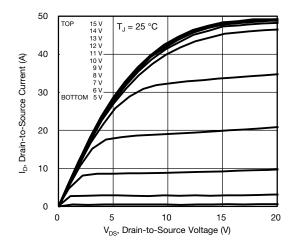


Fig. 1 - Typical Output Characteristics

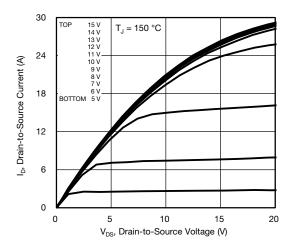
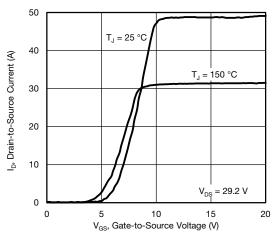


Fig. 2 - Typical Output Characteristics





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3.0 = 11 A R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.5 1.0 10 \ GS 0.5 0 -20 -60 -40 20 40 60 80 100 120 140 160 0

Fig. 4 - Normalized On-Resistance vs. Temperature

T<sub>J</sub>, Junction Temperature (°C)

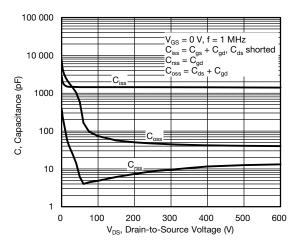


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

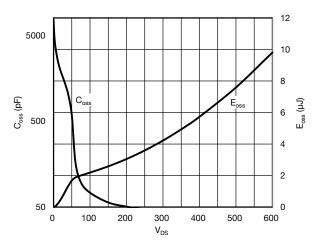


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

3 For technical questions, contact: <u>hvm@vishay.com</u>

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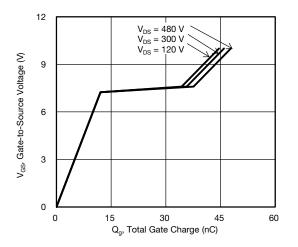


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

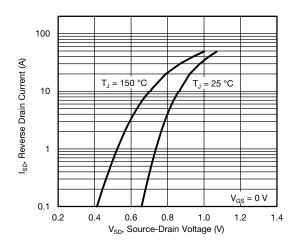


Fig. 8 - Typical Source-Drain Diode Forward Voltage

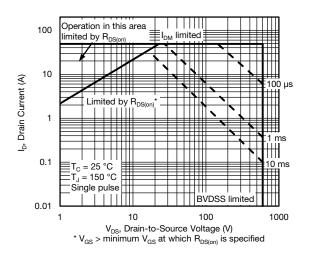


Fig. 9 - Maximum Safe Operating Area

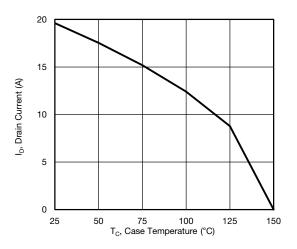


Fig. 10 - Maximum Drain Current vs. Case Temperature

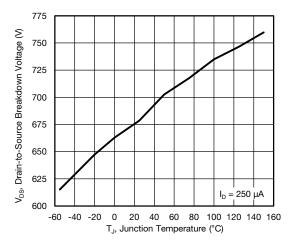
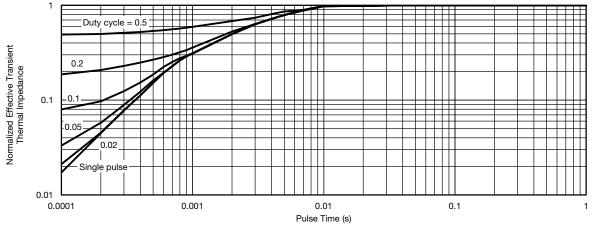


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4



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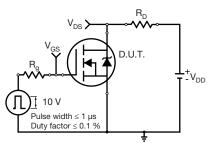


Fig. 13 - Switching Time Test Circuit

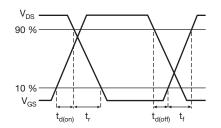


Fig. 14 - Switching Time Waveforms

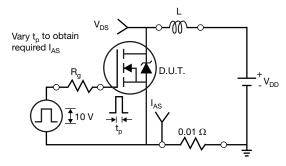


Fig. 15 - Unclamped Inductive Test Circuit

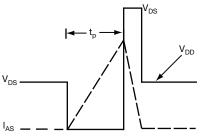


Fig. 16 - Unclamped Inductive Waveforms

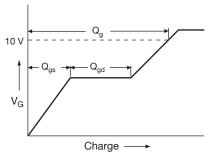


Fig. 17 - Basic Gate Charge Waveform

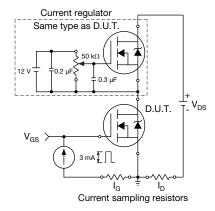
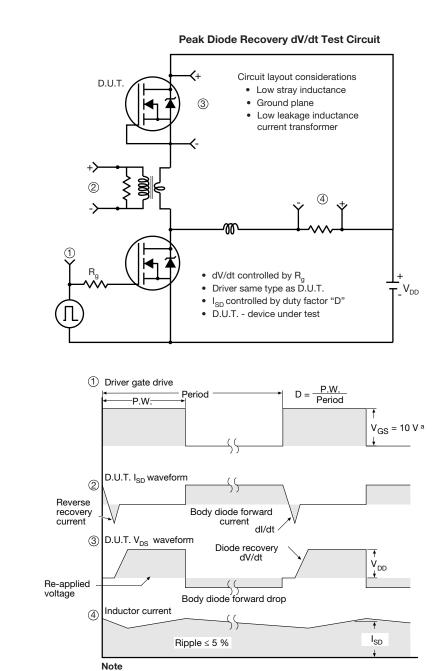


Fig. 18 - Gate Charge Test Circuit

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a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

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# SiHG22N60AE

## Vishay Siliconix



# TO-247AC (High Voltage)

## VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØP	3.56	3.65	7
Ø P1	7.19	) ref.	
Q	5.31	5.69	
S	5.54	5.74	

### Notes

- <sup>(1)</sup> Package reference: JEDEC<sup>®</sup> TO247, variation AC
- (2) All dimensions are in mm
- <sup>(3)</sup> Slot required, notch may be rounded
- <sup>(4)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(5)</sup> Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



## VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
A	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
с	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØΡ	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

### Notes

- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994
- <sup>(2)</sup> Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- <sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- <sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c



## VERSION 3: FACILITY CODE = N



	MILLIN	<b>IETERS</b>		MILLIN	IETERS
DIM.	MIN.	MAX.	DIM.	MIN.	MAX
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	е	5.46	BSC
b1	0.99	1.35	k	0.2	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

<sup>(2)</sup> Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")



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